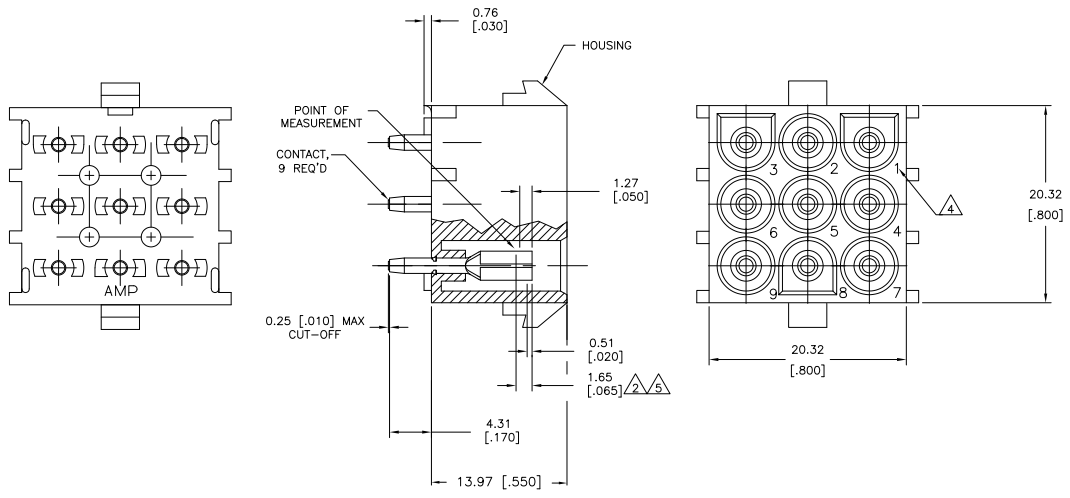
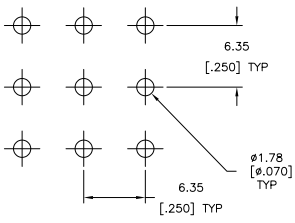


REV	DATE	DESCRIPTION	BY	CHK	APP
CM 00					
R1		REVISED PER ECO-09-013221	DAK/MS	HMR	MS



- PARTS MUST COMPLY WITH AMP SOLDERABILITY SPEC 109-11-3.
- CONTACT IS STAMPED FROM PRE-PLATED STOCK WHICH IS PLATED OVERALL WITH 0.00127 [0.00050] NICKEL, THEN STRIPED WITH 0.00076 [0.00030] GOLD IN CONTACT AREA INDICATED AND TIN-LEAD ON SOLDER TAIL END.
- CIRCUIT IDENTIFICATION CHARACTERS ARE ADJACENT TO THE INDICATED CAVITIES, BUT LOCATION AND ORIENTATION MAY DIFFER FROM FRONT.
- CONTACT IS PLATED OVERALL WITH 0.00127 [0.00050] NICKEL, THEN 0.00076 [0.00030] GOLD OVER CONTACT. LENGTH INDICATED AND MATTE TIN ON SOLDER TAIL END.
- WILL ACCEPT 1.98[.078] DIA PIN



RECOMMENDED LAYOUT FOR 1.58 [.062] THICK PC BOARD

CONTACT	HOUSING	PART NO
PH BRZ TIN	NYLON,UL 94V-0	350828-5
PH BRZ GOLD	NYLON,UL 94V-0	350828-4
PH BRZ GOLD	NYLON,UL 94V-0	350828-2
PH BRZ TIN	NYLON,UL 94V-0	350828-1



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DESIGNER	DATE	REVISED	BY	CHK	APP
DR	11/02/08	11/02/08	DAK	HMR	MS

9 CIRCUIT UNIVERSAL MATE-N-LOK (TM) P.C. BOARD SOCKET HEADER ASSEMBLY

SEE TABLE

CUSTOMER DRAWING

DATE: 5.1 SHEET: 1 OF 1 REV: R1